

LMP02P15JZF 150V P-Channel MOSFET
Features

- -150V/-1A, $R_{DS(ON)} < 750m\Omega @ V_{GS} = -10V$
- Fast switching
- Improved dv/dt capability
- Green Device Available
- SOT-23 package design

especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are well suited for high efficiency fast switching applications.

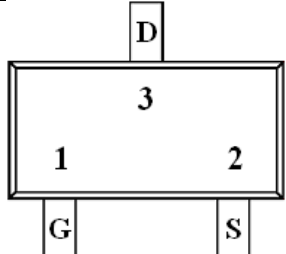
Product Description

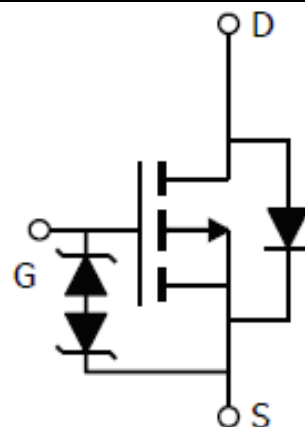
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been

Applications

- Networking
- Load Switch
- LED Application

Pin Configuration

LMP02P15JZF (SOT-23)	
	
PIN	Description
1	Gate
2	Drain
3	Source



Ordering Information

Ordering Information					
Part Number	P/N	PKG code	Pb Free code	Package	Quantity
LMP02P15JZF	LMP02P15	JZ	F	SOT-23	3000

Marking Information

Marking Information		
Part Marking	Part Number	LFC code
25PXW	25P	XW

Absolute Maximum Ratings

(T_C=25°C Unless otherwise noted)

Symbol	Parameter	Typical	Unit
V _{DS}	Drain-Source Voltage	-150	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current- Continuous (T _C =25°C)	-1	A
	Drain Current- Continuous (T _C =100°C)	-0.63	A
I _{DM}	Drain Current- Pulsed ¹	-4	A
P _D	Power Dissipation (T _C =25°C)	1.56	W
	Power Dissipation –Derate above 25°C	0.012	W/°C
T _J	Operating Junction Temperature Range	-50 to 150	°C
T _{STG}	Storage Temperature Range	-50 to 150	°C
R _{θJA}	Thermal Resistance-Junction to ambient	80	°C/W

Electrical Characteristics

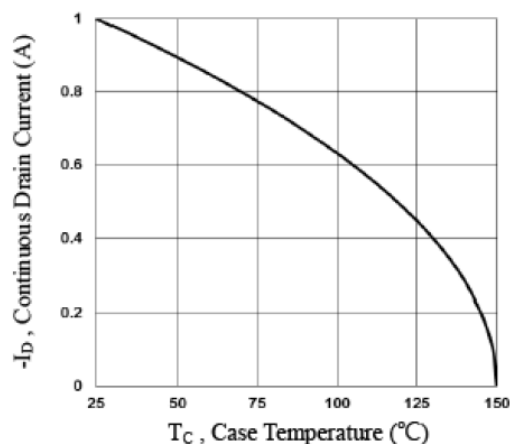
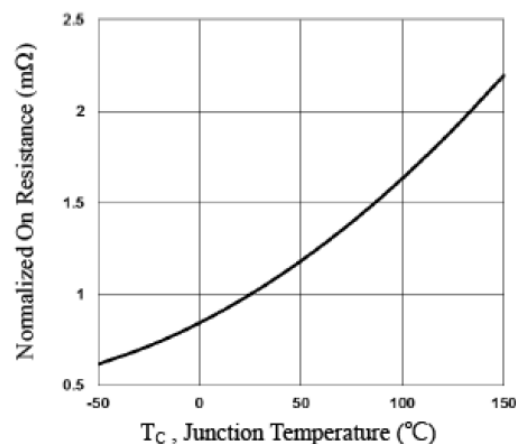
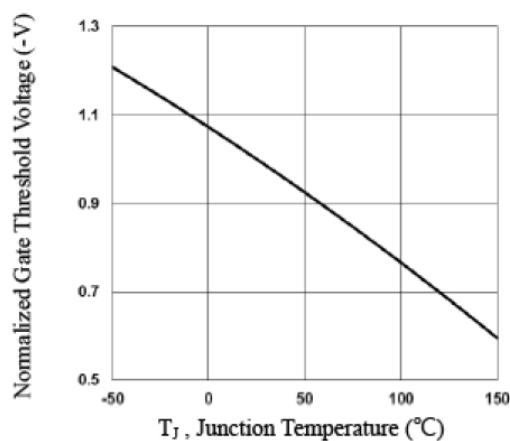
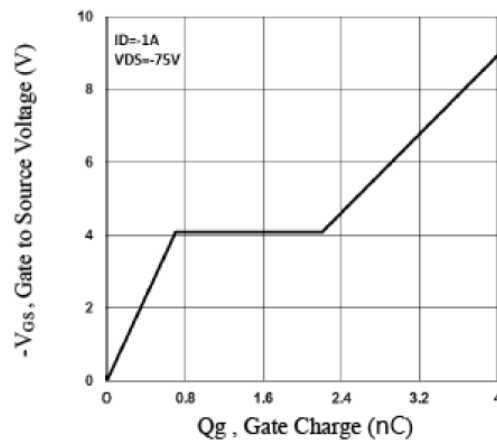
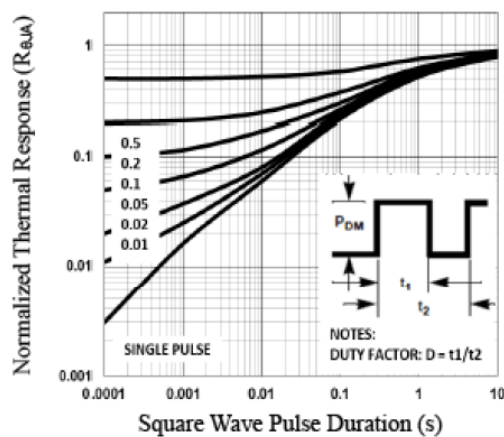
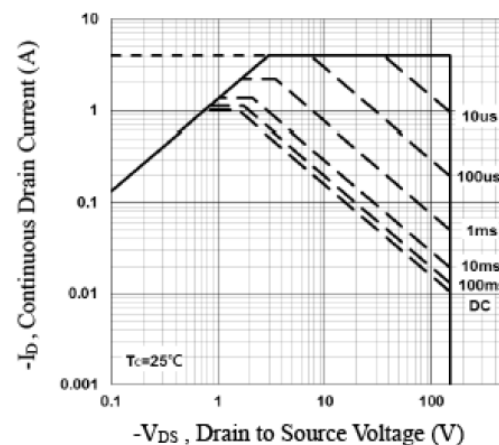
(T_C=25°C Unless otherwise noted)

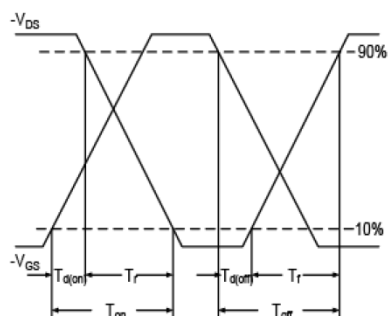
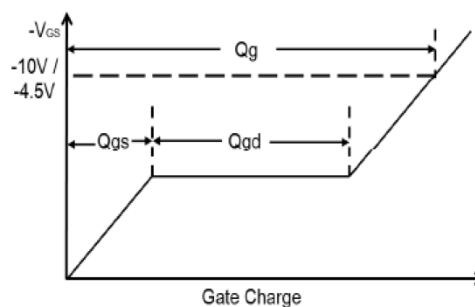
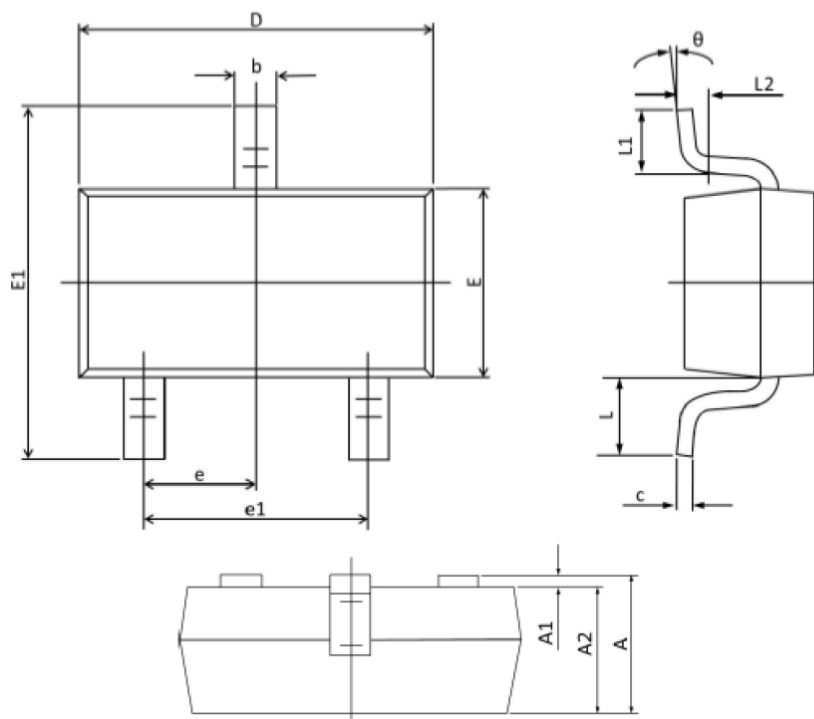
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	-150	---	---	V
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-2	-3	-4	
I _{GSS}	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =±20V	---	---	±100	nA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-150V, V _{GS} =0V, T _J =25°C	---	---	-1	μA
		V _{DS} =-120V, V _{GS} =0V, T _J =125°C	---	---	-10	
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} =-10V, I _D =-1A	---	650	800	mΩ
		V _{GS} =-6V, I _D =-0.5A	---	700	950	
V _{SD}	Diode Forward Voltage	I _S =-1A, V _{GS} =0V, T _J =25°C	---	---	-1	V
I _S	Continuous Source Current	V _{GS} =V _D =0V, Force Current	---	---	-1	A
I _{SM}	Pulsed Source Current		---	---	-2	A
g _{FS}	Forward Transconductance	V _{DS} =-10V, I _D =1A	---	2	---	S
R _g	Gate resistance	V _{DS} =0V, V _{GS} =0V, F=1MHz	---	30	60	Ω
Dynamic						
C _{iss}	Input Capacitance	V _{DS} =-25V, V _{GS} =0V, F=1MHz	---	430	700	pF
C _{oss}	Output Capacitance		---	38	60	
C _{rss}	Reverse Transfer Capacitance		---	28	56	
Q _g	Total Gate Charge ^{2,3}	V _{DS} =-75V, V _{GS} =10V, I _D =-1A	---	4.4	8	nC
Q _{gs}	Gate-Source Charge ^{2,3}		---	0.7	2	
Q _{gd}	Gate-Drain Charge ^{2,3}		---	1.5	3	
t _{d(on)}	Turn-On Time ^{2,3}	V _{DD} =-75V, V _{GS} =-10V, R _G =10Ω, I _D =-1A	---	12.5	20	ns
t _r			---	8.9	18	
t _{d(off)}	Turn-Off Time ^{2,3}		---	17.3	36	
t _f			---	11.5	24	

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

Typical Performance Characteristics


Fig.1 Continuous Drain Current vs. T_C

Fig.2 Continuous Drain Current vs. T_C

Fig.3 Normalized V_{th} vs. T_J

Fig.4 Gate Charge Waveform

Fig.5 Normalized Transient Impedance

Fig.6 Maximum Safe Operation Area

Typical Performance Characteristics(continue)

Fig.7 Switching Time Waveform

Fig.8 Gate Charge Waveform
Package Dimension:
SOT-23


Dimensions				
SYMBOL	Millimeters		Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.008
D	2.800	3.000	0.110	0.006
E	1.200	1.400	0.047	0.118
E1	2.250	2.550	0.089	0.055
e	0.950 (TYP)		0.037 (TYP)	
e1	1.800	2.000	0.071	0.079
L	0.55(REF)		0.028 (REF)	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

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